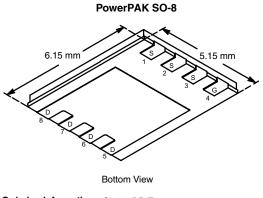


ROHS COMPLIANT

Vishay Siliconix

N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)			
40	0.009 at V _{GS} = 10 V	17			
	0.012 at V _{GS} = 4.5 V	15			



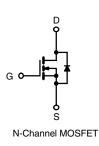
Ordering Information: Si7848DP-T1 Si7848DP-T1—E3 (Lead (Pb)-free)

FEATURES

- TrenchFET[®] Power MOSFETS
- New Low Thermal Resistance PowerPAK[®] Package with Low 1.07-mm Profile
- · PWM Optimized for Fast Switching
- 100 % R_g Tested

APPLICATIONS

- DC/DC Converters
- Synchronous Buck
 - Synchronous Rectifier



ABSOLUTE MAXIMUM RATINGS $\ensuremath{T_{\!\mathcal{A}}}$	∖ = 25 °C, unle	ss otherwise r	noted			
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V _{DS}	40		V	
Gate-Source Voltage		V _{GS}	± 20			
Continuous Drain Current (T _{.1} = 150 °C) ^a	T _A = 25 °C	I _D	17	10.4		
Continuous Drain Current $(T_J = 150 \text{ C})$	T _A = 70 °C		13.7	8.3	А	
Pulsed Drain Current		I _{DM}	50		A	
Avalanche Current	L = 0.1 mH	I _{AS}	30			
Continuous Source Current (Diode Conduction) ^a		۱ _S	4.5	1.67		
Maximum Davier Dissignational	T _A = 25 °C	Pn	5	1.83	W	
Maximum Power Dissipation ^a	T _A = 70 °C	טי	3.2	1.2	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	– 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b,c}			260			

THERMAL RESISTANCE RATINGS Parameter Symbol Typical Maximum Unit $t \le 10 \text{ sec}$ 20 25 R_{thJA} Maximum Junction-to-Ambient^a Steady State 55 68 °C/W Steady State Maximum Junction-to-Case (Drain) 1.8 2.2 R_{thJC}

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

* Pb containing terminations are not RoHS compliant, exemptions may apply.

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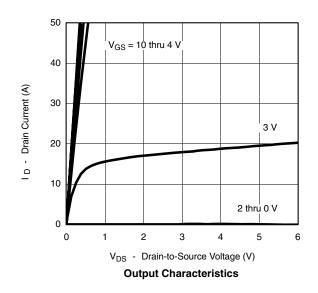


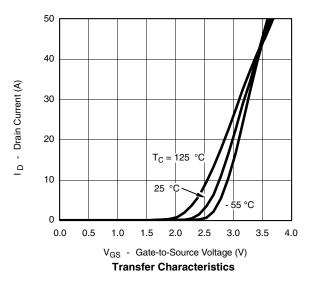
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static	-,			-71-			
Gate Threshold Voltage V _{GS(th)}		$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.0		3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 V, V_{GS} = 0 V$			1		
		V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 55 °C	5	μΑ			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50			А	
	_	V _{GS} = 10 V, I _D = 14 A	0.0075 0.00		0.009		
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 12 \text{ A}$		0.0095	0.012	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 14 A		50		S	
Diode Forward Voltage ^a	V _{SD}	$I_{S} = 2.8 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.1	V	
Dynamic ^b	II						
Total Gate Charge	Qg			18.5	28		
Gate-Source Charge	Q _{gs}	$V_{DS} = 20$ V, $V_{GS} = 5$ V, $I_{D} = 14$ A		6		nC	
Gate-Drain Charge	Q _{gd}			7.5			
Gate Resistance	Rg		0.1	0.8	1.1	Ω	
Turn-On Delay Time	t _{d(on)}			15	30		
Rise Time	t _r	V_{DD} = 20 V, R_L = 20 Ω		10	20	ns	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 1 A, V_GEN = 10 V, R_G = 6 Ω		50	100		
Fall Time	t _f			20	40		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.8 A, di/dt = 100 A/µs		30	60		

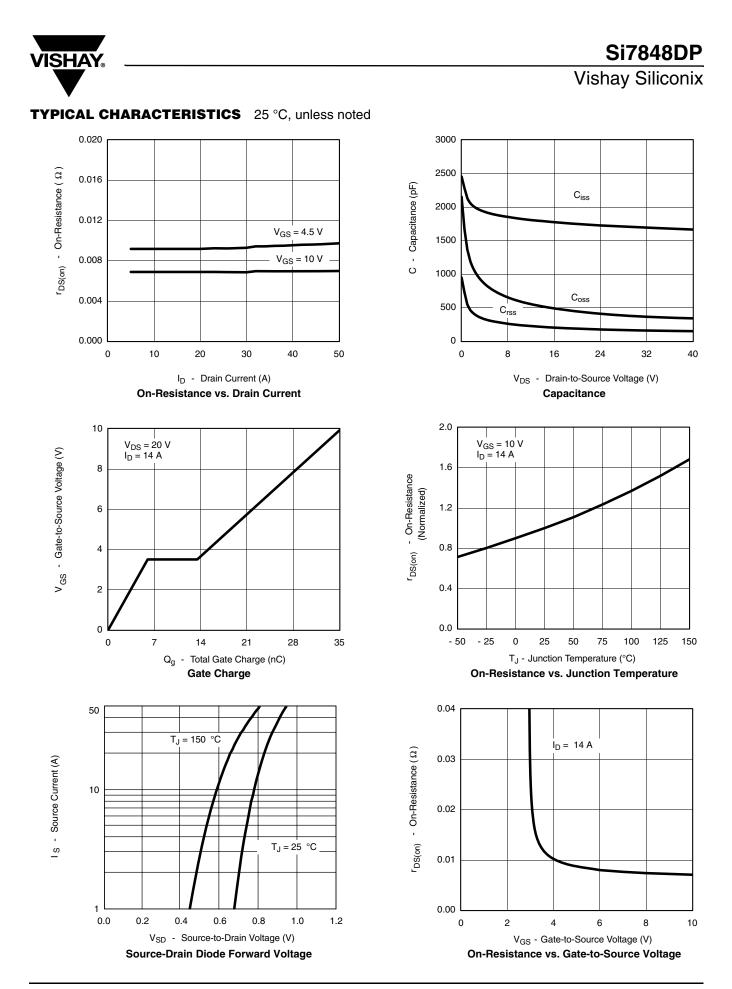
Notes a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted

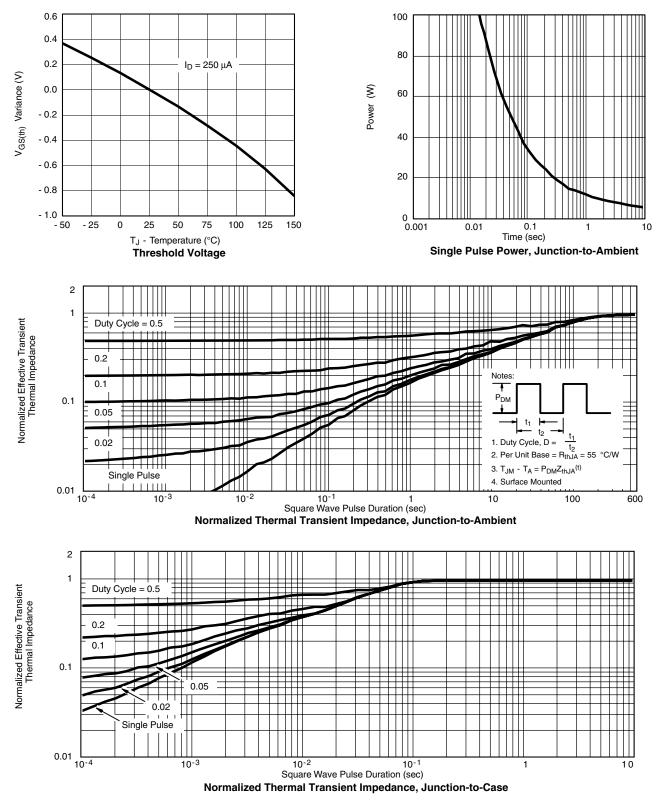






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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71450.



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